

SIM Connector Series

L-KLS1-SIM-076-6P-H1.35-R NANO SIM CARD/NO-PUSH 1.35H/WITH POST

MATERIAL:

Insulator: High Temperature Thermoplastic, III 94V-0 Contact: C5210 SHELL: SUS

PLATING:

Contact: Plated 50u'' Ni Overall Contact ALL Au 1U, Shell: Plated 50u'' Ni Overall, PAD Au 1U

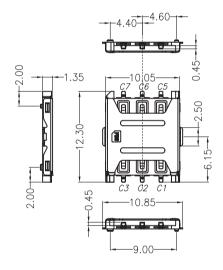
Current Rating :0.5mA AC/DC max. Voltage Rating :125V AC/DC

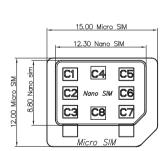
Ambient Temperature Range :-20° C~+60° C Storage Temperature Range :-40° C~+70° C Ambient Humidity Range :95% R.H. Max. Contact Resistance:100mΩmax. Insulation Resistance:1000MΩmin./500VDC Mating Cycles: 10,000 Insertions

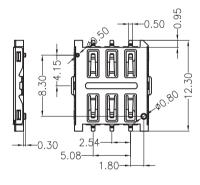
Reflow peak temp.: 260° C $\pm 5^{\circ}$ C, $3^{\circ}5$ S

Mating Cycles: 3,000 Insertions Min

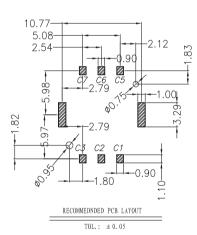








SIM pin assignment	
PIN#	Name
C1	VCC供电电压
C2	RST重置
C3	CLK时钟
C5	GND接地
C6	VPP程序电压
C7	1/0输入输出



ORDER INFORMATION

Product NO.: L-KLS1-SIM-076-6P-H1.35-R Pos. NO. --SIM Card Connector Type